AN7112

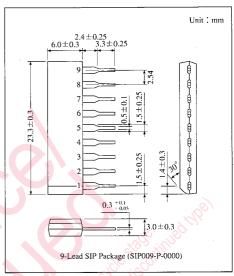
0.5W Audio Power Amplifier Circuit

Overview

The AN7112 is an integrated circuit designed for 0.5W audio power amplifier.

■ Features

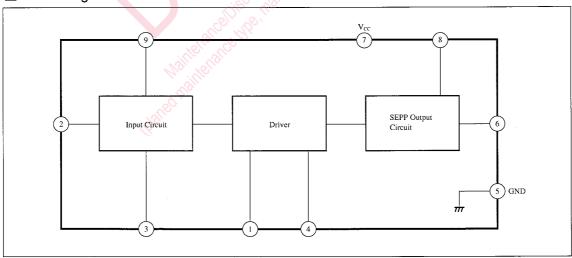
- Wide operating supply voltage range : $V_{CC} = 4V \sim 14V$
- Low quiescent current : $I_{CQ} = 15 \text{mA}$ (at $V_{CC} = 6 \text{V}$, $R_L = 8$ Ω)



Pin Descriptions

Pin No.	Pin Name
1/6	Phase Compensation
2	Input
3	Negative Feedback
4	Phase Compensation
5	GND
6	Output
7	V _{CC}
8	Bootstrap
9	Ripple Filter

■ Block Diagram

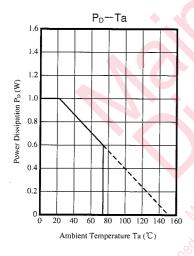


■ Absolute Maximum Ratings (Ta=25°C)

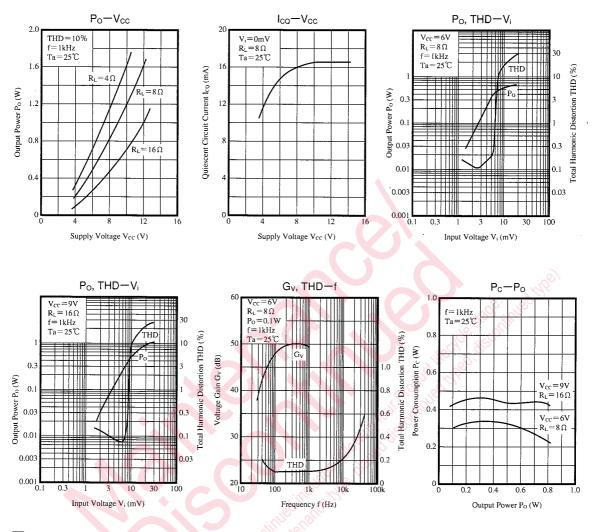
Parameter	Symbol	Rating	Unit	
Supply Voltage	V _{cc}	14	V	
Total Supply Current	I _{CC (peak)}	500	mA	
Power Dissipation	P _D	1	W	
Operating Ambient Temperature	Topr	−25 ~+75	°C	
Storage Temperature	T _{stg}	-55 ~ +150	C	

■ Electrical Characteristics ($V_{CC}=6V, R_L=8\Omega, f=1kHz, Ta=25^{\circ}C$)

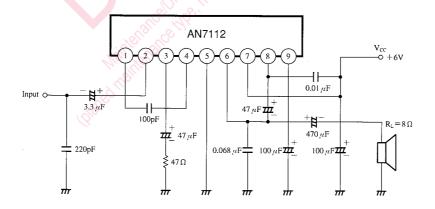
Parameter	Symbol	Condition	min.	typ.	max.	Unit
***	I_{CQ}	$V_{CC}=4V, V_i=0mV$	5			mA
Quiescent Circuit Current	I_{CQ}	$V_{CC}=6V, V_i=0mV$		15	20	mA
-	I_{CQ}	$V_{CC}=9V, V_i=0mV$	_	17	23	mA
Open Circuit Voltage Gain	Gvo	$P_0 = 100 \text{mW}, R_{NF} = 0 \Omega$	65	71		dB
Closed Circuit Voltage Gain	G_{VC}	$P_0 = 100 \text{mW}, R_{NF} = 47 \Omega$	47	50	52	dB
	Po	$V_{CC} = 6V, THD = 10\%$	0.45	0.5		W
Maximum Output Power	Po	$V_{CC} = 9V, R_L = 16\Omega,$ THD=10%		0.7	06-116g	w
Total Harmonic Distortion	THD	$P_0 = 100 \text{mW}$		0.3	1.0	%
Input Resistance	R _i			15	0	kΩ
Output Noise Voltage	V _{no}	BW=50Hz \sim 20kHz, R _g =10k Ω		0.4	1.0	mV



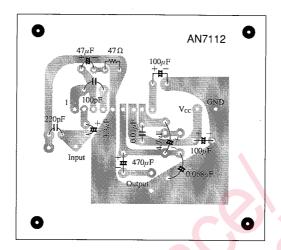




Application Circuit



Printed Circuit Board Layout





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